

Product Change Notification - RMES-02PWOV621

Date:

28 Oct 2019

Product Category:

Memory

Affected CPNs:

7 🖹

Notification subject:

CCB 3832 Final Notice: Qualification of MTAI as a new final test site for selected products of the 0.25 um wafer technology available in 32L PDIP (0.600 in) package.

Notification text:

PCN Status:

Final notification

PCN Type:

Manufacturing Change

Microchip Parts Affected:

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:

Qualification of MTAI as a new final test site for selected products of the 0.25 um wafer technology available in 32L PDIP (0.600 in) package.

Pre Change:

Tested at KYE final test site

Post Change:

Tested at MTAI final test site

Pre and Post Change Summary:

	Pre Change	Post Change							
Final Test Site	Limited	Microchip Technology Thailan (HQ)							
	(KYE)	(MTAI)							
Base Quantity Multiple (BQM)	11	11							
Tube Color and Dimension	No Change								
Packing Method	Minor Packing changes (see attached)								

Impacts to Data Sheet:

None

Change Impact:

None

Reason for Change:

To improve on-time delivery performance by qualifying MTAI as a new final test site.

Change Implementation Status:

In Progress

Estimated First Ship Date:



November 28, 2019 (date code: 1948)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change partsTime Table Summary:

	July 2019				October 2019				November 2019						
Workweek	27	28	29	30	31		40	41	42	43	44	45	46	47	48
Initial PCN		Х				->									
Qual Report Availability											Х				
Final PCN Issue Date											Х				
Estimated															V
Implementation Date															^

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History:

July 09, 2019: Issued initial notification.

October 28, 2019: Issued final notification. Attached the qualification report. Provided estimated first ship date to be on November 28, 2019.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_RMES-02PWOV621_Qual_Report.pdf PCN_RMES-02PWOV621 PRE AND POST CHANGE_SUMMARY.pdf

Please contact your local <u>Microchip sales office</u> with questions or concerns regarding this notification.

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Affected Catalog Part Numbers (CPN)

SST39SF040-70-4C-PHE SST39SF020A-70-4C-PHE SST39SF010A-70-4C-PHE